

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	7650121
<b>Application Number:</b>	10580361
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	1718
<b>Title of Invention:</b>	Production Of Semiconductor Substrates With Buried Layers By Joining (Bonding) Semiconductor Wafers
<b>First Named Inventor/Applicant Name:</b>	Roy Knechtel
<b>Customer Number:</b>	29673
<b>Filer:</b>	Robert L. Showalter/Sandy Moles
<b>Filer Authorized By:</b>	Robert L. Showalter
<b>Attorney Docket Number:</b>	LEO 003 PA
<b>Receipt Date:</b>	20-MAY-2010
<b>Filing Date:</b>	18-APR-2007
<b>Time Stamp:</b>	11:08:50
<b>Application Type:</b>	U.S. National Stage under 35 USC 371

### Payment information:

Submitted with Payment	yes
Payment Type	Electronic Funds Transfer
Payment was successfully received in RAM	\$1110
RAM confirmation Number	9494
Deposit Account	
Authorized User	

### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/Message Digest	Multi Part/.zip	Pages (if appl.)

1		LEO003PA_Amendment_05_20 _10.pdf	120560 bc5d869663d2aec06081924d33080f4ea5b 3c360	yes	11
<b>Multipart Description/PDF files in .zip description</b>					
<b>Document Description</b>		<b>Start</b>		<b>End</b>	
Amendment/Req. Reconsideration-After Non-Final Reject		1		1	
Claims		2		6	
Drawings-only black and white line drawings		7		7	
Applicant Arguments/Remarks Made in an Amendment		8		11	

**Warnings:****Information:**

2	Drawings-only black and white line drawings	LEO003PA_replacement_drawing_with_heading_PTO.pdf	426531 c06577e3cc557255b8f38317d9b653d55bf 49950	no	1
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**Warnings:****Information:**

3	Extension of Time	LEO003PA_Extension_of_Time.pdf	230015 e8165d0d60f73d55976bbe4f79f0b92fbbe 9f36	no	1
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**Warnings:****Information:**

4	Fee Worksheet (PTO-875)	fee-info.pdf	30396 aa8fe828fe1f3c69f42b114bf97ab8d9edff4 461	no	2
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**Warnings:****Information:**

<b>Total Files Size (in bytes):</b>			807502
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This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

**New Applications Under 35 U.S.C. 111**

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.